

# INTERNATIONAL STANDARD

**Materials for printed boards and other interconnecting structures –  
Part 2-46: Reinforced base materials clad and unclad – Non-halogenated  
epoxide non-woven/woven E-glass reinforced laminate sheets of thermal  
conductivity 1,5 W/(m·K) and defined flameability (vertical burning test),  
copper-clad for lead-free assembly**



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INTERNATIONAL  
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COMMISSION

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## INTERNATIONAL ELECTROTECHNICAL COMMISSION

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The text of this International Standard is based on the following documents:

CDV	Report on voting
91/1448/CDV	91/1484/RVC

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

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### Part 2-46: Reinforced base materials clad and unclad – Non-halogenated epoxide non-woven/woven E-glass reinforced laminate sheets of thermal conductivity 1,5 W/(m•K) and defined flammability (vertical burning test), copper-clad for lead-free assembly

#### 1 Scope

This part of IEC 61249 gives requirements for properties of non-halogenated epoxide non-woven reinforced core/woven E-glass reinforced surface laminate sheets of thermal conductivity and defined flammability (vertical burning test), copper-clad for lead-free assembly in thicknesses of 0,60 mm up to 1,70 mm. The flammability rating is achieved through the use of non-halogenated fire retardants reacted as part of the epoxide polymeric structure. The glass transition temperature is defined to be 105 °C minimum. Thermal conductivity is defined to be  $(1,5 \pm 0,2)$  W/(m•K).

#### 2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 61189-2:2006, *Test methods for electrical materials, printed boards and other interconnection structures and assemblies – Part 2: Test methods for materials for interconnection structures*

IEC 61249-5-1, *Materials for interconnection structures – Part 5: Sectional specification set for conductive foils and films with and without coatings – Section 1: Copper foils (for the manufacture of copper-clad base materials)*

IEC/PAS 61249-6-3, *Specification for finished fabric woven from "E" glass for printed boards*

ISO 11014, *Safety data sheet for chemical products – Content and order of sections*

#### 3 Terms and definitions

No terms and definitions are listed in this document.

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